

ESLABS.003A



PATENT

1-6-03
Amdr
18/c

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Knowles, et al.
Appl. No. : 09/593,587
Filed : June 13, 2000
For : THERMAL INTERFACE
Examiner : Leonard R. Leo

Group Art Unit 3743

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: United States Patent and Trademark Office, P.O. 2327, Arlington, VA 22202, on

12/17/03
(Date)
James F. Herkenhoff
James F. Herkenhoff Reg. No 51,241

AMENDMENT PURSUANT TO 37 C.F.R. § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RECEIVED

DEC 29 2003

INTRODUCTORY COMMENTS

TECHNOLOGY CENTER R3700

Dear Sir:

In response to the Office Action mailed October 1, 2003, Applicant respectfully submits the following amendments and comments in connection with the above-captioned application. Changes to pending claims have been identified with underlining to indicate insertions and by strikethrough to indicate deletions.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.

12/24/2003 HDEHESS1 00000017 09593587

01 FC:2201

86.00 DP